Press release
Communiqué de presse
Comunicato stampa

新闻稿 ／ 新聞稿
プレスリリース
보도자료

PR No: C3388C

STMicroelectronics to host investor calls on Cloud AI and Intelligent Sensing Enabling Physical AI

Geneva, March 2, 2026 - STMicroelectronics N.V. ("ST") (NYSE: STM) will host two webcasts for investors and analysts in March 2026.

- "*ST for Cloud AI*", hosted by Remi El-Ouazzane, President of ST's MDRF Group. Conference call & webcast on March 9, 2026, at 3.30pm CET / 10.30am ET.

- "*ST Intelligent Sensing Enabling the Physical AI*", hosted by Marco Cassis, President of ST's APMS Group. Conference call & webcast on March 16, 2026, at 3.30pm CET / 10.30am ET.

Presentations will be followed by a Q&A session. A live webcast (listen-only mode) of the conference will be accessible at ST's website, https://investors.st.com, and will be available for replay.

About STMicroelectronics
At ST, we are 48,000 creators and makers of semiconductor technologies mastering the semiconductor supply chain with state-of-the-art manufacturing facilities. An integrated device manufacturer, we work with more than 200,000 customers and thousands of partners to design and build products, solutions, and ecosystems that address their challenges and opportunities, and the need to support a more sustainable world. Our technologies enable smarter mobility, more efficient power and energy management, and the wide-scale deployment of cloud-connected autonomous things. We are on track to be carbon neutral in all direct and indirect emissions (scopes 1 and 2), product transportation, business travel, and employee commuting emissions (our scope 3 focus), and to achieve our 100% renewable electricity sourcing goal by the end of 2027. Further information can be found at www.st.com.

INVESTOR RELATIONS
Jérôme Ramel
EVP Corporate Development & Integrated External Communication
Tel: +41.22.929.59.20
jerome.ramel@st.com

MEDIA RELATIONS
Alexis Breton
Group VP Corporate External Communications
Tel: +33.6.59.16.79.08
alexis.breton@st.com